ABSOCIATION CONNECTING ELECTROWICS INDUSTRIES International and P	IPC, Bannock	burn, Illinois. A	ll rights reserved un tions.	nder both	This docum level parts, t	ent is a decla	tration of t	the substance passes all low	s within the er level mat	manufacture erials for wh	er listed ite	em. Note: anufactur	if the item is a er has engineer	n assembly with lower ng responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Information															
Company name*	Company uni	Company unique ID			Unique ID Authority					Response Date*					
onsemi											2025-06-04				
Contact Name	Title - Contac	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Envir	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
Authorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com							
Requester Item Number	Mfr Iter	n Number	Mfr Item Name			Effective D	ve Date Version Manufacturing Site		v	Veight*	UOM	Unit Type			
	NCP176	NCP176BMX100TCG LDO 1.		LDO 1.0V HZ		2025-06-04	ŀ.		ТНВ		1	.81	mg	Each	
Manufacturing Proccess Inform	ation		<u>.</u>								ł		ł	L	
Terminal Plating / Grid Array N	/aterial '	Terminal Base Alloy		J-STD-020 MSL Rating		Peak Process Body Ten		dy Temperatu	perature Max Time at Peak T		Cemperature Number of Reflow Cycles		Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		l		260		C	30		second	conds 3			
Comments															
evel 1 - maximum time at peak tempera	ture during so	dering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed								
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (100 PPM) in homogeneous material for: Lead ercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl te (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, hyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part blicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, racknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. In information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of								
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted									
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.													
Exemption List Version	EL-2011/534/EU												
Declaration Signature													
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.													
Supplier Digital Signature Ra	stislav Drska	Le											

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.09	mg	Supplier	Silicon (Si)	7440-21-3		0.09	mg	
Die Attach	0.04	mg	Supplier	Silver (Ag)	7440-22-4		0.03	mg	
			Supplier	Epoxy resins	129915-35-1		0.01	mg	
Lead Frame	0.78	mg	Supplier	Tin (Sn)	7440-31-5		0.0019	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.0017	mg	
			Supplier	Chromium (Cr)	7440-47-3		0.0019	mg	
			Supplier	Copper (Cu)	7440-50-8		0.7744	mg	
Mold Compound-Black	0.87	mg		Epoxy Phenol Resin	proprietary data		0.0913	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.7786	mg	
Plating	0.01	mg	Supplier	Palladium (Pd)	7440-05-3		0.0005	mg	
			В	Nickel (Ni)	7440-02-0		0.009	mg	
			Supplier	Gold (Au)	7440-57-5		0.0005	mg	
Wire Bond	0.02	mg	Supplier	Palladium (Pd)	7440-05-3		0.0002	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0198	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).